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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







## TVS Diode Arrays (SPA® Diodes)

Lightning Surge Protection- AQ4023 Series

## AQ4023 Series 1.3pF, 12A Discrete TVS Diode









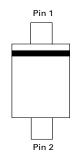




#### **Description**

The AQ4023 Series integrates low capacitance steering diodes with one or two avalanche breakdown diodes for unidirectional or bidirectional protection, respectively, to protect against ESD and lightning induced surge events. These components can safely absorb up to 12A per IEC 61000-4-5 2<sup>nd</sup> edition (t<sub>a</sub>=8/20µs) without performance degradation and a minimum ±30kV ESD per IEC 61000-4-2 International Standard. The low loading capacitance and high surge capability make it ideal for protecting telecommunication ports such as xDSL and other high voltage, high speed legacy interfaces.

#### **Pinout**



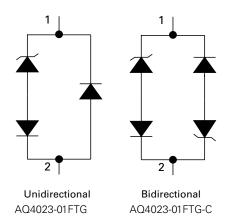
Cathode polarity for unidirectional only

#### **Features**

- ESD, IEC 61000-4-2, ±30kV contact, ±30kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, IEC 61000-4-5 2<sup>nd</sup> edition, 12A  $(t_p = 8/20 \mu s)$
- Low capacitance of 1.3pF (@ V<sub>R</sub>=0V)
- · Low leakage current

- Unidirectional and bidirectional configuration
- Small SOD323 package fits 0805 footprints
- AEC-Q101 qualified
- Moisture Sensitivity Level(MSL -1)
- Halogen free, lead free and RoHS compliant

#### **Functional Block Diagram**



#### **Applications**

- xDSL Interfaces
- RS-232
- RS-485
- Power Ports
- Security Equipment
- Instrumentation
- Medical Equipment
- Computers and Peripherals
- CAN Bus protection
- Automotive applications

Life Support Note:

#### Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

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Revision: 03/07/18

## TVS Diode Arrays (SPA® Diodes)

Lightning Surge Protection-AQ4023 Series

### **Absolute Maximum Ratings**

Symbol	mbol Parameter		Units
I <sub>PP</sub>	Peak Current (t <sub>p</sub> =8/20µs)	12	А
$P_{Pk}$	Peak Pulse Power (t <sub>p</sub> =8/20µs)	450	W
T <sub>OP</sub>	Operating Temperature	-40 to 150	°C
T <sub>STOR</sub>	Storage Temperature	-55 to 150	°C

#### Notes:

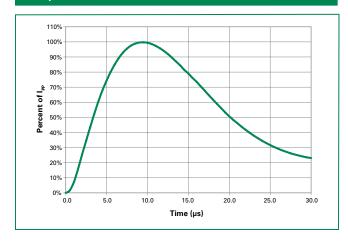
CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### **Electrical Characteristics** (T<sub>OP</sub>=25°C)

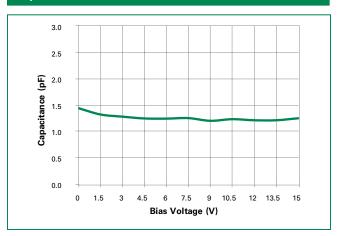
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Reverse Standoff Voltage V <sub>RWM</sub>		I <sub>R</sub> ≤1μA with Pin 1 to Pin 2			15	V
Breakdown Voltage	V <sub>BD</sub>	I <sub>T</sub> =1mA with Pin 1 to Pin 2	16			V
Leakage Current I <sub>LEA</sub>		V <sub>R</sub> =15V with Pin 1 to Pin 2			0.1	μΑ
	V <sub>c</sub>	I <sub>PP</sub> =1A, t <sub>p</sub> =8/20μs, Fwd		23		V
Clamp Voltage <sup>1</sup>		I <sub>PP</sub> =2A, t <sub>p</sub> =8/20μs, Fwd		24		V
		I <sub>pp</sub> =10A, t <sub>p</sub> =8/20μs, Fwd		35		V
		I <sub>pp</sub> =12A, t <sub>p</sub> =8/20μs, Fwd		37.5		V
Dynamic Resistance <sup>2</sup>	R <sub>DYN</sub>	TLP t <sub>p</sub> =100ns, Pin 1 to Pin 2		0.55		Ω
ESD Withstand Voltage <sup>1</sup>	V <sub>ESD</sub>	IEC 61000-4-2 (Contact Discharge)	±30			kV
		IEC 61000-4-2 (Air Discharge)	±30			kV
Diode Capacitance <sup>1</sup>	C <sub>D</sub>	Reverse Bias=0V, f=1MHz, Pin 1 to Pin 2		1.3	2	pF

Note:

#### 8/20µs Pulse Waveform



#### Capacitance vs. Reverse Bias (Pin 1 to Pin 2)



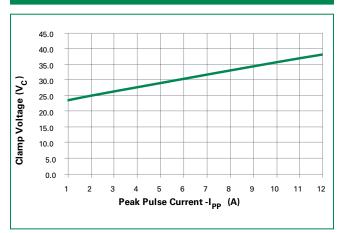
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<sup>1</sup>Parameter is guaranteed by design and/or component characterization.

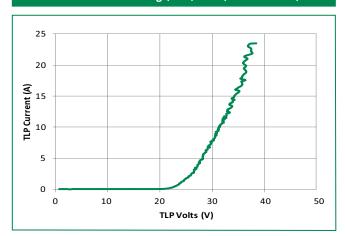
 $<sup>2\,</sup> Transmission\, Line\, Pulse\, (TLP)\, test\, setting: Std.TDR(50\Omega), tp=100ns,\, tr=0.2ns\, ITLP\, and\, VTLP\, averaging\, window:\, start\, 1=70ns\, to\, end\, t2=80ns\, transmission\, transmissio$ 



#### Clamping Voltage vs. Peak Pulse Current (Pin 1 to Pin 2)

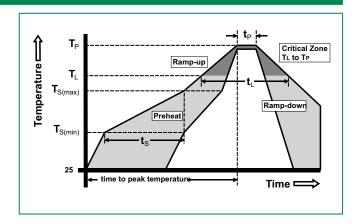


#### Transmission Line Pulsing (TLP) Plot (Pin 1 to Pin2)



## **Soldering Parameters**

Reflow Cor	ndition	Pb – Free assembly	
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (min to max) (t <sub>s</sub> )	60 – 180 secs	
Average ra to peak	mp up rate (Liquidus) Temp (T <sub>L</sub> )	3°C/second max	
$T_{S(max)}$ to $T_{L}$	- Ramp-up Rate	3°C/second max	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
nellow	-Temperature (t <sub>L</sub> )	60 – 150 seconds	
Peak Temp	erature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C	
Time within 5°C of actual peak Temperature (t <sub>p</sub> )		20 – 40 seconds	
Ramp-dow	n Rate	6°C/second max	
Time 25°C	to peak Temperature (T <sub>P</sub> )	8 minutes Max.	
Do not exceed		260°C	



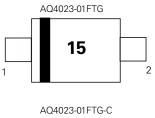
#### **Product Characteristics**

Lead Plating	Matte tin
Lead Material	Copper Alloy
Lead Coplanarity	0.0004 inches (0.102mm)
Substrate material	Silicon
Body Material	Molded Compound
Flammability	UL Recognized compound meeting flammability rating V-0

- All dimensions are in millimeters
   Dimensions include solder plating.
   Dimensions are exclusive of mold flash & metal burr.

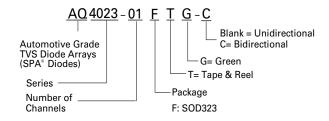


#### **Part Marking System**





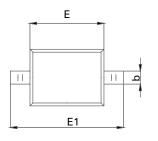
#### **Part Numbering System**

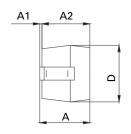


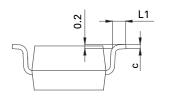
#### **Ordering Information**

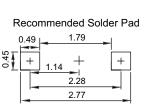
Part Number	Package	Marking	Min. Order Oty.
AQ4023-01FTG	SOD323	15	3000
AQ4023-01FTG-C	SOD323	15C	3000

### **Package Dimensions -SOD323**









Unit: mm

		COL	2222		
	SOD323				
Symbol	Millimeters		Inches		
	Min	Max	Min	Max	
Α	0.80	1.00	0.031	0.039	
<b>A</b> 1	0.00	0.10	0.000	0.004	
A2	0.80	0.90	0.031	0.035	
b	0.25	0.35	0.010	0.014	
С	0.08	0.15	0.003	0.006	
D	1.20	1.40	0.047	0.055	
E	1.60	1.80	0.063	0.071	
E1	2.50	2.70	0.098	0.106	
L1	0.25	0.40	0.010	0.016	

A0

B0 W

D0

D1

E1

**E2** 

P0

Р

**P1** 

K0

Т

1.46+/-0.10

2.90+/-0.10

8.0+0.3/-0.10

1.50+0.10

0.45min/1.15max

1.75+/-0.10

3.50+/-0.10

4.00+/-0.10

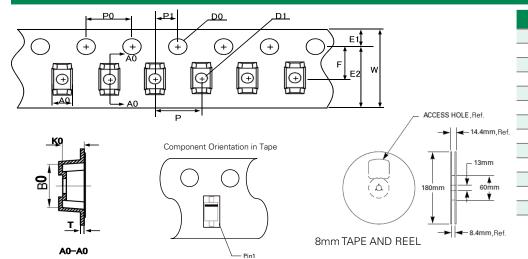
4.00+/-0.10

2.00+/-0.05

1.25+/-0.10

0.254+/-0.02

#### Embossed Carrier Tape & Reel Specification — SOD323



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